

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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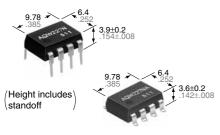


Panasonic

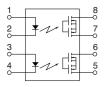
P

DIP8-pin type featuring low on-resistance 200V/400V load voltage

PhotoMOS® RF 2 Form A Low on-resistance (AQW22ON)



mm inch



RoHS compliant

FEATURES

- 1. 2-channels (Form A) type with high response speed, low leakage current and low on-resistance.
- 2. Applicable for 2 Form A use as well as two independent 1 Form A use
- 3. Low capacitance between output terminals ensures high response speed:

The capacitance between output terminals is small; typ. 10 pF.
This enables for a fast operation speed of typ. 0.2 ms.

4. High sensitivity and low onresistance:

Max. 0.07 A of load current can be controlled with input current of 5 mA. The on-resistance is less than our conventional models.

5. Low-level off state leakage current

6. Controls low-level analog signals:

PhotoMOS features extremely low closed-circuit offset voltages to enable control of small analog signals without distortion.

TYPICAL APPLICATIONS

• Measuring instruments
Scanner, IC checker, Board tester, etc.

TYPES

	Output rating*			Part No.					
			- Package	Through hole terminal	s	Surface-mount termin	Packing quantity		
	Load	Load	Package	Tube packing style		Tape and reel packing style			
	voltage	current				Picked from the 1/2/3-pin side	Picked from the 4/5/6-pin side	Tube	Tape and reel
AC/DC dual use	200 V	50 mA	DIP8-pin	AQW227N	AQW227NA	AQW227NAX	AQW227NAZ	1 tube contains: 50 pcs.	1,000 pcs.
	400 V	40 mA		AQW224N	AQW224NA	AQW224NAX	AQW224NAZ	1 batch contains: 500 pcs.	1,000 pcs.

^{*}Indicate the peak AC and DC values.

Note: The surface mount terminal indicator "A" and the packing style indicator "X" or "Z" are not marked on the device.

RATING

1. Absolute maximum ratings (Ambient temperature: 25°C 77°F)

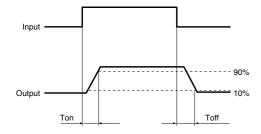
	Item	Symbol	AQW227N(A)	AQW224N(A)	Remarks
Input	LED forward current	le le	50 mA		
	LED reverse voltage	VR	5 V		
	Peak forward current	IFP	1 A		f = 100 Hz, Duty factor = 0.1%
	Power dissipation	Pin	75 mW		
Output	Load voltage (peak AC)	VL	200 V	400 V	
	Continuous load current	IL	0.05 A (0.07 A)	0.04 A (0.05 A)	Peak AC, DC (): in case of using only 1 channel
	Peak load current	Ipeak	0.15 A	0.12 A	A connection: 100 ms (1 shot), V _L = DC
	Power dissipation	Pout	800 mW		
Total power dissipation		Рт	850 mW		
I/O isolation voltage		Viso	1,500 V AC		
Temperature limits	Operating	Topr	-40°C to +85°C -40°F to +185°F		Non-condensing at low temperatures
	Storage	T _{stg}	-40°C to +100°C -40°F to +212°F		

2. Electrical characteristics (Ambient temperature: 25°C 77°F)

Item				AQW227N(A)	AQW224N(A)	Remarks
	LED anarota aurrent	Typical		0.9 mA		I∟ = Max.
Input	LED operate current	Maximum	Fon	3.0 mA		
	LED turn off current	Minimum	I	0.4 mA		IL = Max.
	LED turn on current	Typical	Foff	0.8 mA		
	LED dropout voltage	Typical	VF	1.25 V (1.14 V at I _F = 5 mA)		I _F = 50 mA
	LED dropout voltage	Maximum	V F	1.5 V		
Output	On resistance	Typical	Ron	30 Ω	70 Ω	I _F = 5 mA
		Maximum		50 Ω	100 Ω	I∟ = Max. Within 1 s on time
		Typical		10 pF		I _F = 0 V _B = 0 f = 1 MHz
	Output capacitance	Maximum	Cout	15 pF		
	Off state leakage current	Maximum	Leak	10 nA (1 nA or less)*		I _F = 0 V _L = Max.
Transfer characteristics	Turn on time**	Typical	Ton	0.2 ms		I _F = 5 mA I _L = Max.
	Turri on time	Maximum	Ion	0.5 ms		
	Turn off time**	Typical	Toff	0.08 ms		I _F = 5 mA I _L = Max.
	Turri on time	Maximum	IOIT	0.2 ms		
	I/O capacitance	Typical	Ciso	0.8 pF		f = 1 MHz V _B = 0
	и сараспансе	Maximum	Ciso	1.5 pF		
	Initial I/O isolation resistance	Minimum	Riso	1,000 ΜΩ		500 V DC

^{*}Available as custom orders (1 nA or less)

^{**}Turn on/Turn off time



RECOMMENDED OPERATING CONDITIONS

Please obey the following conditions to ensure proper device operation and resetting.

Item	Symbol	Recommended value	Unit	
Input LED current	lF	5	mA	

■ These products are not designed for automotive use.

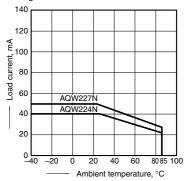
If you are considering to use these products for automotive applications, please contact your local Panasonic Corporation technical representative.

REFERENCE DATA

1. Load current vs. ambient temperature characteristics

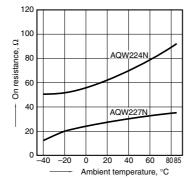
Allowable ambient temperature: -40°C to +85°C

When using 2 channels



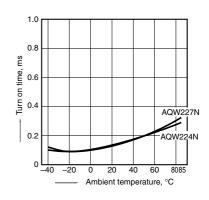
2. On resistance vs. ambient temperature characteristics

Measured portion: between terminals 5 and 6, 7 and 8; LED current: 5 mA; Load voltage: Max. (DC); Continuous load current: Max. (DC)



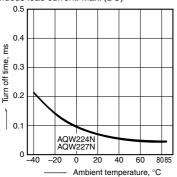
3. Turn on time vs. ambient temperature characteristics

LED current: 5 mA; Load voltage: Max. (DC); Continuous load current: Max. (DC)

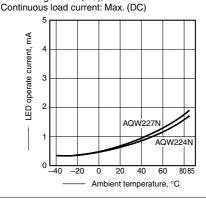


4. Turn off time vs. ambient temperature characteristics

LED current: 5 mA; Load voltage: Max. (DC); Continuous load current: Max. (DC)

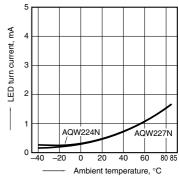


5. LED operate current vs. ambient temperature characteristics
Load voltage: Max. (DC);



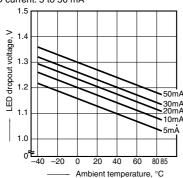
6. LED turn off current vs. ambient temperature characteristics

Load voltage: Max. (DC); Continuous load current: Max. (DC)



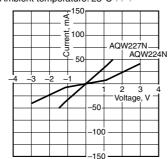
7. LED dropout voltage vs. ambient temperature characteristics Sample: All types;

LED current: 5 to 50 mA



8. Voltage vs. current characteristics of output at MOS portion

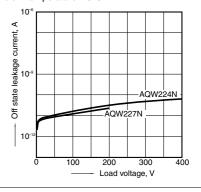
Measured portion: between terminals 5 and 6, 7 and 8; Ambient temperature: 25°C 77°F



9. Off state leakage current

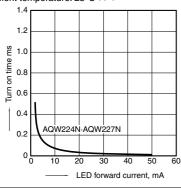
Measured portion: between terminals 5 and 6, 7 and 8:

Ambient temperature: 25°C 77°F



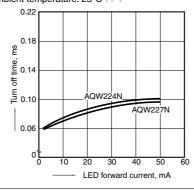
10. LED forward current vs. turn on time characteristics

Measured portion: between terminals 5 and 6, 7 and 8; Load voltage: Max. (DC); Continuous load current: Max. (DC); Ambient temperature: 25°C 77°F



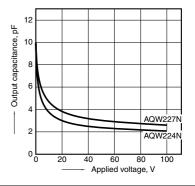
11. LED forward current vs. turn off time characteristics

Measured portion: between terminals 5 and 6, 7 and 8; Load voltage: Max. (DC); Continuous load current: Max. (DC); Ambient temperature: 25°C 77°F



12. Applied voltage vs. output capacitance characteristics

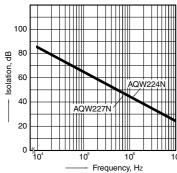
Measured portion: between terminals 5 and 6, 7 and 8; Frequency: 1 MHz, 30 mVrms; Ambient temperature: $25^{\circ}C$ $77^{\circ}F$



13. Isolation characteristics (50 Ω impedance)

Measured portion: between terminals 5 and 6, 7 and 8;

Ambient temperature: 25°C 77°F



14. Insertion loss characteristics (50 Ω impedance)

Measured portion: between terminals 5 and 6, 7 and 8;

Ambient temperature: 25°C 77°F

